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Designed for: Public Release		Mod. Date: 8/14/2014	
Project Title: TPS92210 30W Flyback			
Sheet Title: PMP6023-1			
Number: PMP6023-1	Rev: E1	Assembly Variant: [No Variations]	
SVN Rev: Not in version control		Sheet: 1 of 2	
Drawn By: David Zhang		File: PMP6023-1_E1.SchDoc	
Engineer: David Zhang		Size: B	
Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		http://www.ti.com	
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H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C

FID1 FID2 FID3

PCB Number: PMP6023-1  
PCB Rev: E1

PCB  
LOGO  
Texas Instruments

ZZ1  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ4  
Assembly Note  
Install 'C8' bent over horizontally & apply RTV167 to secure to the PCB surface, bend radius should follow best practice guidelines.

ZZ5  
Assembly Note  
'C8' is a non-IPC compliant, custom footprint

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Designed for: Public Release	Mod. Date: 8/14/2014
Project Title: TPS92210 30W Flyback	
Sheet Title: Hardware	
Number: PMP6023-1	Rev: E1
SVN Rev: Not in version control	Assembly Variant: [No Variations]
Drawn By: David Zhang	File: PMP6023-1_E1_Hardware.SchDoc
Engineer: David Zhang	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>
	Sheet: 2 of 2
	Size: B

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